

AMENDMENT TO THE SPECIFICATION

Please replace the paragraph beginning at page 13, line 2, with the following rewritten paragraph:

Finally, as shown in Fig. 10, electronic parts, for example chip type electronic parts 6 such as resistors and capacitors, are mounted on the third insulating layer 23. As to these chip type electronic parts 6, the second conductive circuit 19 and electrodes 601 of the chip type electronic parts 6 are electrically connected to each other through via 340 by virtue of solder or a conductive bonding agent (step S19). It is preferable to mount a connector, or the like, used to install the circuit board 1 in electronic equipment (not shown) through the via 340.